503122039 01/03/2015

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHANGHAI ZHIJING BIOLOGICAL TECHNOLOGY CO., LTD.	12/16/2014
FUDAN UNIVERSITY	12/16/2014

RECEIVING PARTY DATA

Name:	SHANGHAI ZHIJING BIOLOGICAL TECHNOLOGY CO., LTD.	
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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13555167

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NAME OF SUBMITTER:	LEI GU
SIGNATURE:	/Lei Gu/
DATE SIGNED:	01/03/2015

Total Attachments: 1

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PATENT 503122039 REEL: 034622 FRAME: 0866

ASSIGNMENT

WHEREAS, I (we), 1. Shanghai Zhijing Biological Technology Co., Ltd. 2. Fudan University whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have made a invention entitled: Large-scale data processing cloud computing system (hereinafter referred to as the INVENTION) for which an application for United States Letters Patent was executed on even data herewith executed on: filed on: 07/22/2012 Serial No.: 13/555,167
WHEREAS, Shanghai Zhijing Biological Technology Co., Ltd. whose post office address is Room 109, No. 1 Building, No. 211 Xinling Road, Minhang District, Shanghai 201199, China
hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in and to the same in the United States;
NOW, THEREFORE, for good and valuable consideration, receipt of which is herebacknowledged, I (we), ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-parameters and reissue of said application.
ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required to connection with the filing, prosecution and maintenance of said application or any other pater application(s) in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify an communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the INVENTION that are within ASSIGNOR'S possession or control, and to provide further assurances are testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heir executors, administrators and other legal representatives.
ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademark to issue any and all Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, tit and interest in and to the same, for ASSIGNEE'S sole use and behoof, and for the use and behoof assignee's legal representatives and successors, to the full end of the term for which such Letters Paten may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.
ASSIGNOR requests that you direct all correspondence to customer number 15598 - Lei Yu.
ASSIGNOR NAME: Lei Gu
ADDRESS: No. 220 Handan Road, Shanghai 200433, China
/ Lei Gu/ 12/16/2014 SIGNATURE DATE

RECORDED: 01/03/2015

PATENT REEL: 034622 FRAME: 0867